VLMU35CL2.-275-120

Vishay Semiconductors

UVC Emitting Diode in SMD Package



www.vishay.com

DESCRIPTION

VLMU35CL2.-275-120 is a ceramic based low power UVC LED with silicone lens for long life time. The package size is 3.45 mm x 3.45 mm x 1.38 mm and the radiant power typically 3 mW at 20 mA in a wavelength range of 265 nm to 285 nm.

PRODUCT GROUP AND PACKAGE DATA

- Product group: LED
- Package: SMD ceramic
- Product series: standard power UV LED
- Angle of half intensity: ± 60°
- · Lead-finishing: Au

FEATURES

- Ceramic SMT package with silicone lens
- Dimension (L x W x H) in mm: 3.45 x 3.45 x 1.38
- DC forward current: up to 30 mA
- Radiant power (typ.): 3 mW at 20 mA and 4.3 mW at 30 mA
- Leads / terminations finish: gold plated (Au)
- · Reflow soldering method
- MSL 3 according to J-STD-020
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

APPLICATIONS

- Sterilization
- Medical application
- Sensing of gases, germs, DNA, ...

SAFETY ADVICES

These LEDs emit very strong UV radiation during operation. Do not look directly into the LED light when in operation as UV radiation can harm your eyes. To prevent inadequate exposure, wear protective eyewear. If LEDs are embedded in devices, please indicate warning labels. Avoid exposure to skin or other tissue during operation. Keep out of the reach of children. Take appropriate precautions around pets and other living organisms to avoid UV exposure.

PARTS TABLE														
PART	COLOR (mW)		at WA		VELENGTH (nm)		at I _F	FORWARD VOLTAGE (V)		at I _F	TECHNOLOGY			
		MIN.	TYP.	MAX.	(mA)	MIN.	TYP.	MAX.	(mA)	MIN.	TYP.	MAX.	(mA)	
VLMU35CL20-275-120	Ultraviolet	2.0	3.0	-	20	265	277	285	20	5.0	6.0	7.0	20	AlGaN

ABSOLUTE MAXIMUM RATINGS (T _{amb} = 25 °C, unless otherwise specified) VLMU35CL2275-120								
PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT				
DC forward current		I _F	30	mA				
Power dissipation		Pv	0.21	W				
Reverse voltage		Not designed for reverse operation						
Electrostatic discharge	HBM: MIL-STD-883 C 3B	ESD	2000	V				
Junction temperature		Tj	+90	°C				
Operating temperature range		T _{amb}	-40 to +80	°C				
Storage temperature range		T _{stg}	-40 to +100	°C				
Solder temperature		T _{sol}	260	°C				



RoHS COMPLIANT HALOGEN FREE GREEN

(5-2008)

ARE SUBJECT TO SPECIFIC DISCLAIMERS, SET FORTH AT www.vishav.com/doc?91000





www.vishay.com

Vishay Semiconductors

OPTICAL AND ELECTRICAL CHARACTERISTICS ($T_{amb} = 25$ °C, unless otherwise specified) VLMU35CL2275-120, ULTRAVIOLET								
PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT		
Forward voltage	I _F = 20 mA	V _F	5.0	6.0	7.0	V		
Dediestressen	I _F = 20 mA	1	2.0	3.0	-	mW		
Radiant power	I _F = 30 mA	фе	-	4.3	-			
Ratio of radiant intensity/radiant power	I _F = 20 mA	I _e /φ _e	-	0.34	-	sr-1		
Peak wavelength	I _F = 20 mA	λρ	265	277	285	nm		
Angle of half intensity	I _F = 20 mA	φ	-	± 60	-	o		
Thermal resistance junction to solder-point	Soldered on 20 x 20 x 1.7 (in mm) AI MCPCB	R _{thJS}	-	38	-	K/W		

Note

- Tolerances: \pm 11 % for $\phi_e,$ \pm 0.1 V for V_F, \pm 3 nm for λ_p

RADIANT POWER CLASSIFICAT	ANT POWER CLASSIFICATION (I _F = 20 mA)							
GROUP	MIN.	MAX.	UNIT					
X1	2.0	-	mW					

PEAK WAVELENGTH CLASSIFICATION ($I_F = 20 \text{ mA}$)							
GROUP	MIN.	MAX.	UNIT				
W1	265	285	nm				

FORWARD VOLTAGE CLASSIFICATION ($I_F = 20 \text{ mA}$)							
GROUP	UNIT						
V1	5.0	5.5					
V2	5.5	6.0	N/				
V3	6.0	6.5	V				
V4	6.5	7.0					

Note

In order to ensure availability, single groups for radiant intensity, wavelength, and forward voltage will not be orderable. Only one group for
radiant intensity, wavelength, and forward voltage will be shipped in any one reel



TYPICAL CHARACTERISTICS ($T_{amb} = 25$ °C, unless otherwise specified)

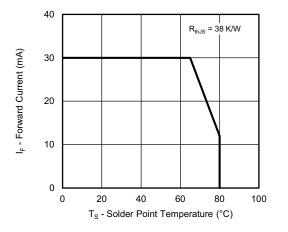


Fig. 1 - Maximum Forward Current vs. Solder Point Temperature

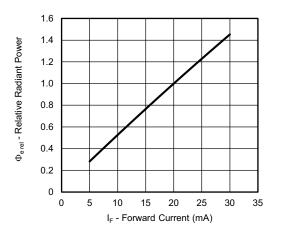


Fig. 2 - Relative Radiant Power vs. Forward Current

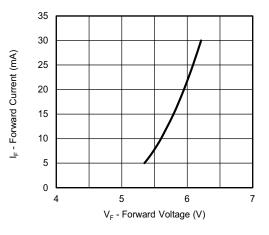


Fig. 3 - Forward Current vs. Forward Voltage

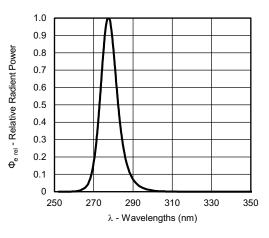


Fig. 4 - Relative Radiant Power vs. Wavelength

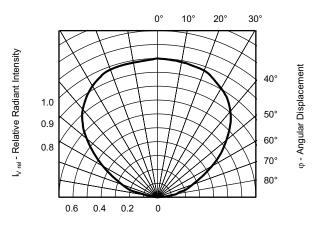


Fig. 5 - Relative Radiant Intensity vs. Angular Displacement

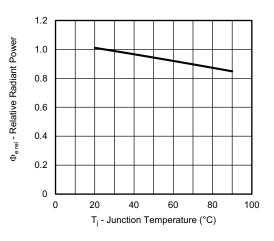


Fig. 6 - Relative Radiant Power vs. Junction Temperature

Document Number: 80254

THIS DOCUMENT IS SUBJECT TO CHANGE WITHOUT NOTICE. THE PRODUCTS DESCRIBED HEREIN AND THIS DOCUMENT ARE SUBJECT TO SPECIFIC DISCLAIMERS, SET FORTH AT <u>www.vishay.com/doc?91000</u>



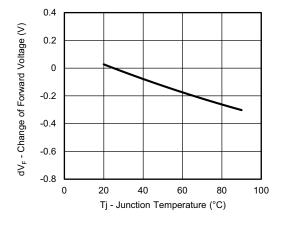
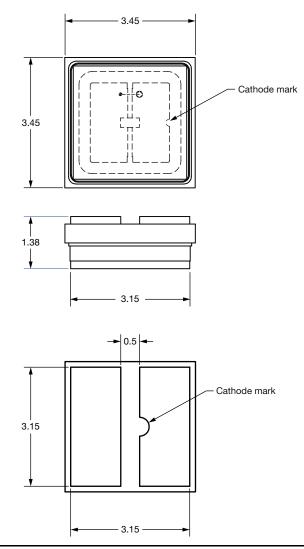
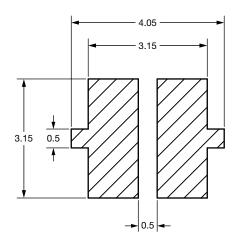


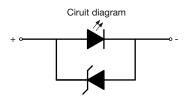
Fig. 7 - Change of Forward Voltage vs. Junction Temperature

PACKAGE DIMENSIONS in millimeters



Recommended solder pad opening

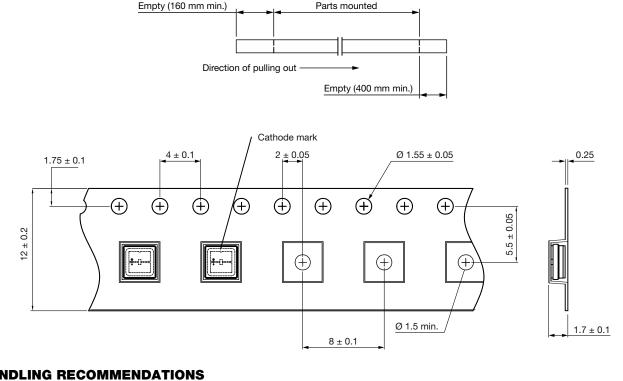




Rev. 1.0, 09-Sep-2020

Document Number: 80254

THIS DOCUMENT IS SUBJECT TO CHANGE WITHOUT NOTICE. THE PRODUCTS DESCRIBED HEREIN AND THIS DOCUMENT ARE SUBJECT TO SPECIFIC DISCLAIMERS, SET FORTH AT www.vishay.com/doc?91000



Х

abel posted here

Tape position coming out from reel 500 pcs/reel

VLMU35CL2.-275-120

Vishay Semiconductors

Technical drawings according to DIN specification

Reel

Ø 178 ±

HANDLING RECOMMENDATIONS

www.vishay.com

TAPE AND REEL DIMENSIONS in millimeters

ŝ + 00

15 ± 1

Leader and trailer tape

Unreel direction

<u>Ø 1</u>3 ^{+0.5} -0.2

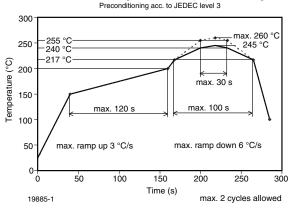
In order to achieve excellent lifetime, the package of these UV-LEDs consists of a ceramic substrate in combination with a UV stable silicone as lens material. Compared to standard materials silicone is generally softer and it tends more to attract dust:

- · Minimize the level of dirt and dust particles in contact with the LED
- Small amounts of particles on the LEDs, although noticeable from a cosmetic point of view, do not affect the performance in terms of brightness, reliability and quality
- If cleaning is required, a short rinsing with isopropy alcohol, not longer than 15 seconds, is recommended. Do not use ultrasonic cleaning, it may damage the LED

- · Do not apply mechanical stress on the silicone lens
- · Avoid any piercing of the silicone lens by sharp objects
- It is recommended to use a suitable pick and place tool for the removal of the LED from blister tape without applying stress to the lens. The recess of the pick-up needle has to be larger than the silicone lens
- · For manual handling using tweezers make sure that the LED will be touched carefully at the sidewall of the ceramic substrate, but not at the silicone lens

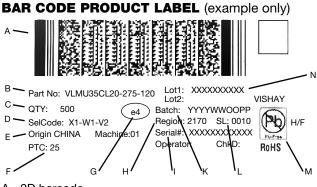


SOLDERING PROFILE



IR Reflow Soldering Profile for Lead (Pb)-free Soldering

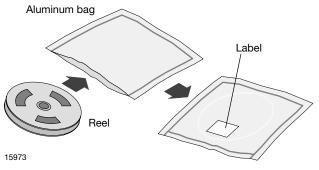
Fig. 8 - Vishay Lead (Pb)-free Reflow Soldering Profile (according to J-STD-020C)



- A. 2D barcode
- B. Part No: Vishay part number
- C. QTY: quantity
- D. SelCode: selection bin code
- E. Country of origin
- F. PTC: production plant code
- G. Termination finish
- H. Region code
- L. Serial#: serial number
- K. Batch number: year, week, country code, plant code
- L. SL: sales location
- M. Environmental symbols: RoHS, lead (Pb)-free, halogen-free
- N. Lot numbers

DRY PACKING

The reel is packed in an anti-humidity bag to protect the devices from absorbing moisture during transportation and storage.



FINAL PACKING

The sealed reel is packed into a cardboard box. A secondary cardboard box is used for shipping purposes.

RECOMMENDED METHOD OF STORAGE

Dry box storage is recommended as soon as the aluminum bag has been opened to prevent moisture absorption. The following conditions should be observed, if dry boxes are not available:

- Storage temperature 10 °C to 30 °C
- Storage humidity \leq 60 % RH max.

After more than 168 h under these conditions moisture content will be too high for reflow soldering.

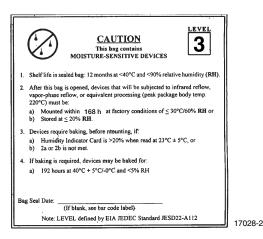
In case of moisture absorption, the devices will recover to the former condition by drying under the following condition:

192 h at 40 °C + 5 °C / - 0 °C and < 5 % RH (dry air / nitrogen) or

24 h at 60 °C + 5 °C and < 5 % RH for all device containers or

24 h at 100 °C + 5 °C not suitable for reel or tubes.

An EIA JEDEC® standard JESD22-A112 level 3 label is included on all dry bags.



Example of JESD22-A112 level 3 label

Rev. 1.0, 09-Sep-2020

Document Number: 80254

6



ESD PRECAUTION

Proper storage and handling procedures should be followed to prevent ESD damage to the devices especially when they are removed from the antistatic shielding bag. Electrostatic sensitive devices warning labels are on the packaging.

VISHAY SEMICONDUCTORS STANDARD BAR CODE LABELS

The Vishay Semiconductors standard bar code labels are printed at final packing areas. The labels are on each packing unit and contain Vishay Semiconductors specific data.



Vishay

Disclaimer

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Vishay makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Vishay disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Vishay's knowledge of typical requirements that are often placed on Vishay products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and / or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Hyperlinks included in this datasheet may direct users to third-party websites. These links are provided as a convenience and for informational purposes only. Inclusion of these hyperlinks does not constitute an endorsement or an approval by Vishay of any of the products, services or opinions of the corporation, organization or individual associated with the third-party website. Vishay disclaims any and all liability and bears no responsibility for the accuracy, legality or content of the third-party website or for that of subsequent links.

Except as expressly indicated in writing, Vishay products are not designed for use in medical, life-saving, or life-sustaining applications or for any other application in which the failure of the Vishay product could result in personal injury or death. Customers using or selling Vishay products not expressly indicated for use in such applications do so at their own risk. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay. Product names and markings noted herein may be trademarks of their respective owners.

© 2024 VISHAY INTERTECHNOLOGY, INC. ALL RIGHTS RESERVED

Revision: 01-Jan-2024